

**INDUSTRY STANDARD OF THE
PEOPLE'S REPUBLIC OF CHINA**

SJ/T 10188-2016

Replacing SJ/T 10188-1991

Design and use guide of printed board assemblies

印制板安装用元器件的设计和使用指南

(English Translation)

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Table of Contents

What this standard covers	1
Document data	2

What this standard covers

This standard specifies the design requirements of the electronic component mounting lands and the size, shape and tolerance of the common component mounting lands to ensure sufficient area of the weld fill, and also allows inspection, testing and repair of the solder joints. It is suitable for the structure of the connecting plate of printed circuit board and the graphic design of the connecting plate.

Document data

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